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Electron Beam-induced Light Emission and Transport in GaN Nanowires

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Abstract— We report observations of electron beam-induced light from GaN nanowires grown by chemical vapor deposition. GaN nanowires were modified *in-situ* with deposited opaque platinum coatings to estimate the extent to which light is channeled to the ends of nanowires. Some evidence of light channeling was found, but wire microstructure and defects play an important role in light scattering and transport, limiting the extent to which light is confined.

Keywords—nanowire, GaN, light, waveguide, optical

I. INTRODUCTION

Optical interconnects are powerful components presently applied for high bandwidth communications among high-performance processors.[1-4] Future circuits based on nanometer-scale components could similarly benefit from optical information transfer among processing blocks. Strong light channeling (and even lasing) has been observed in GaN nanowires, suggesting that these structures could be useful building blocks in a future networked electro-optical processor.[5] However, the extent to which defects and microstructure control optical performance in nanowire waveguides has not been measured. In this study, we use electron microscopy and *in-situ* modification of individual nanowires to begin to correlate wire structure with light transport efficiency through GaN nanowires tens of microns long.

II. EXPERIMENTAL METHODS

GaN nanowires were grown in a horizontal furnace by reacting Ga vapor with ammonia at 850-900 °C as described elsewhere.[6] Ammonia was flowed at 50-100 sccm for 3-4 hours, resulting in a matrix of GaN nanowires and platelets on the nitride boat and quartz furnace liner. Typical nanowire dimensions are 20 μm to 100 μm in length and 100 nm to 400 nm in diameter. The entire matrix was harvested, dissolved in isopropanol and dispersed on single-crystal silicon substrates for subsequent imaging and modification. A dual-beam FEI 620 focused ion beam/scanning electron microscope (FIB/SEM) was used for imaging, cathodoluminescence (optical signal) characterization, and for deposition of opaque Pt pads at the ends of the nanowires, where light emission was expected to be concentrated because of channeling effects.[5] Light was excited in the nanowires by 10 kV electrons with a

nominal beam current of 15 ± 3 nA. Electron-induced optical signals were collected with a 5 mm collimating lens positioned ~ 20 mm from the sample during excitation, and transported out of the SEM vacuum chamber to a cooled spectrometer with UV-visible optical fibers. Background-subtracted signal was integrated for 60 s during every measurement.

As described elsewhere[7], GaN platelets are the source of GaN nanowires, and are typically 0.5 to 5 μm in diameter with the normal of the largest face being parallel to the c-axis ([0001]-type direction) of the wurtzite structure. During growth, nanowires extend from the sides of the platelets such that the growth direction is parallel to the wurtzite a-planes (Fig. 1).

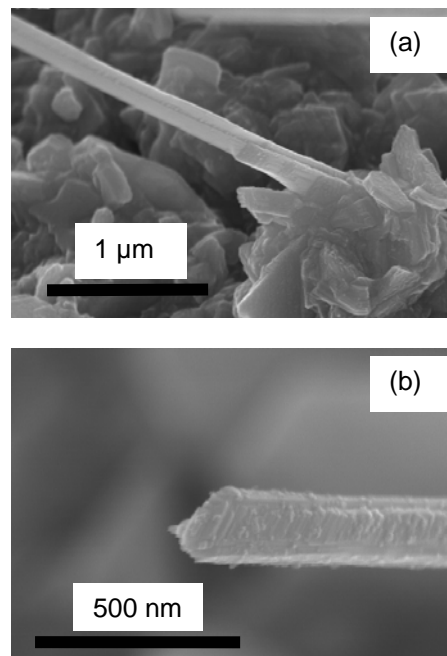


Fig. 1(a) GaN nanowire root attached to matrix (flake) (b) Nanowire tip; growth defects along with the extended structural defects as found in transmission electron microscopy (not shown) may cause light scattering in nanowires.

Upon harvesting, however, nanowires typically break free of the generating platelets. The orientation of both platelets and wires was established by transmission electron microscopy and electron back-scattered diffraction patterns. The thinnest nanowires (<100 nm diameter) are often single crystals, but larger-diameter wires are typically composed of groups of parallel crystals, all with growth directions parallel to the wurtzite a-planes. Polycrystalline nanowires were examined for this study because of their higher absolute levels of light emission.

III. RESULTS

A typical GaN nanowire, 40 μm long and 150-200 nm in diameter, was harvested and placed on a Si substrate as shown in Fig. 2(a). Note the presence of several small GaN platelets and multi-platelet structures also dispersed on the substrate. Cathodoluminescence signals were obtained from wire regions 400 nm wide by 2 μm long, shown schematically in Fig. 2(a). An area larger than the width of the nanowire was selected for measurement to prevent charge accumulation in the wire, and to avoid problems associated with beam drift.

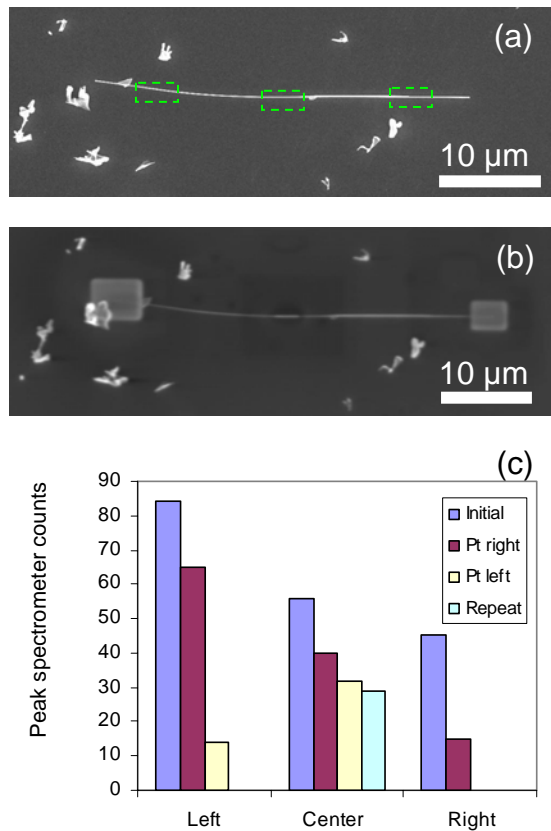


Fig. 2(a) 150-200 nm diameter nanowire before Pt deposition, (b) after Pt deposition, and (c) GaN band gap peak signal at locations shown in (a).

Optical signals were confirmed spectroscopically to have been generated in GaN, and background signals from Si substrate and all other sources were measured to be <10% of the typical

GaN signal. After initial survey of light output from the nanowire excited at various locations, an opaque Pt pad at least ~200 nm thick was deposited on the right side of the nanowire by local electron-beam induced decomposition of the Pt precursor (Trimethyl)methylcyclopentadienyl-platinum. A second opaque Pt pad was deposited on the left. The final structure is shown in Fig. 2(b). The magnitude of the light emission peak associated with the GaN band gap is shown in Fig. 2(c), before and after Pt deposition.

A second nanowire, 300-400 nm in diameter, is shown in Fig. 3(a) before Pt deposition. Fig. 3(b) shows the wire after Pt pad deposition. Cathodoluminescence signals were obtained from areas 2 μm by 500 nm. The magnitude of the GaN band gap-associated optical signal before and after Pt deposition is shown in Fig. 3(c).

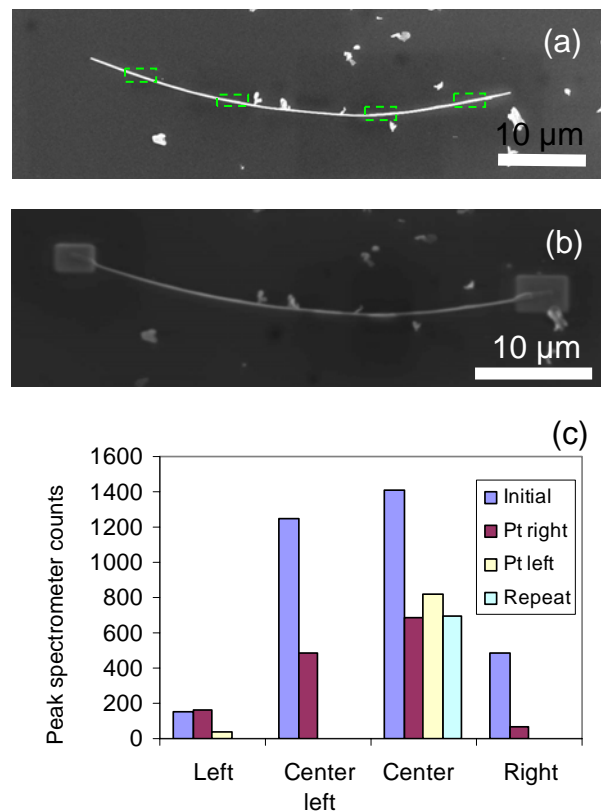


Fig. 3(a) 300-400 nm diameter nanowire before Pt deposition, (b) after Pt deposition, and (c) GaN band gap peak signal at locations shown in (a).

IV. DISCUSSION

Both nanowires exhibited reductions in light intensity following deposition of Pt on one end, disproportionate to the area covered and in areas far away from the deposition location. This is consistent with light channeling, as previously observed in GaN by near-field scanning optical microscopy [5]. However, especially for the 150-200 nm diameter wire, reductions in light intensity were modest. Note

that even without Pt deposition, the same location measured consecutively typically yielded integrated peak values 10-15% lower the second time, possibly due to migration and accumulation of carbon on the GaN nanowires during the long (60 s) integration time necessary for adequate signal to noise levels to be achieved.

Reductions in light intensity observed after right side Pt deposition at the center left and center positions of the 300-400 nm diameter wire, and at the left position of the 150-200 nm diameter wire, suggest that some channeled light is being blocked by the deposited Pt. However, when both ends are blocked, light from the center-excited wire does not drop to near-background levels, indicating some light is being emitted all along the length of the wire. Light scattering along the length of the wire is likely facilitated by the presence of extended defects such as stacking faults and surface steps along the sides of the nanowires. Previously, low-defect nanowires have been observed to be frequently oriented with the long direction parallel to [0001]. However, among [0110]-oriented wires, internal defects and surface steps are common [8]. Since our wires were primarily [0110]-oriented, it is not unexpected that extended defects are present as observed by SEM (Fig. 1), and each of these defects can act as a scattering center. It is interesting to note that the light intensity from center-excited wires drops most when the side which was initially brightest is covered, indicating that light generated in the wires may have been preferentially channeled to this end. Light may be blocked at the other end by defects or the presence of a residual metallic precursor.

Dramatic reductions in light intensity at the ends of the nanowires following Pt deposition on those same ends may result from light being blocked by Pt outside of the target deposition area. Note, however, that 10 keV electrons readily traverse 200 nm-thick Pt: the range for 10 keV electrons in Pt is estimated to 370 nm in the continuous slowing-down approximation[9]. Therefore, even if the beam is focused on a Pt-covered area, light will still be generated. However, this light will be readily absorbed by the Pt. Using Lambert's law with an absorption coefficient of $2.3 \times 10^5 \text{ cm}^{-1}$ for 3.4 eV light (appropriate for light generated from the GaN band gap), we calculate that a 200 nm-thick Pt layer is sufficient to reduce light intensity by a factor of $\sim 2 \times 10^8$. Although no Pt was observed on the wires outside of the target area, the effect on optical signals of Pt deposition outside of the target regions cannot be excluded and may even affect the center areas. Since similar thicknesses of Pt were deposited on left and right sides of the wires, however, and since the effects on wire light emission of outside-target Pt coverage is likely cumulative, it is reasonable to expect that center-excited light would drop similarly after Pt deposition on right and left sides. Especially for the 300-400 nm wire, however, this is not observed. Instead, light drops significantly following Pt deposition on the right side, and even increases slightly following Pt deposition on the left side, again suggesting a degree of light channeling.

V. SUMMARY

Light emission observed from Pt-modified GaN wires, 200-400 nm in diameter, is consistent with light channeling to the ends, though some light emission is found to occur all along the length of the nanowires. Extended defects such as stacking faults and surface steps likely cause significant scattering which limits the performance of these large-diameter nanowires as waveguides. Smaller nanowires with fewer defects are presently under investigation for comparison.

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